M JJMICROELECTRONICS

80V, 137A, 2.4mΩ N-channel Power SGT MOSFET JMSL0803MG

Features

- Excellent $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$ and Low Gate Charge
- 100% UIS TESTED
- 100% ΔVds TESTED
- Halogen-free; RoHS-compliant
- Pb-free plating

Applications

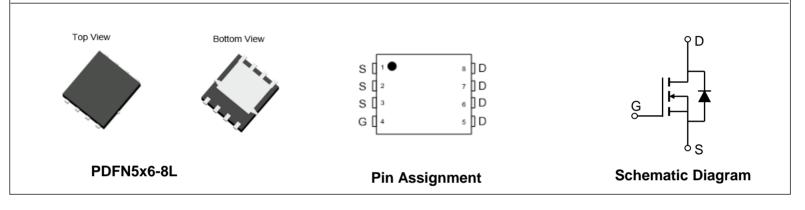
- Load Switch
- PWM Application
- Power Management

Product Summary

Parameters	Value	Unit
V _{DSS}	80	V
V _{GS(th)_Typ}	1.6	V
I _D (@V _{GS} =10V)	137	А
R _{DS(ON)_Typ} (@V _{GS} =10V	2.4	mΩ







Ordering Information

Device	Marking	MSL	Form	Package	Reel Size	Reel(pcs)	Per Carton (pcs)
JMSL0803MG	L0803M	1	Tape&Reel	PDFN5x6-8L	13"	5000	50000

Absolute Maximum Ratings (@ T_c = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V _{DS}	Drain-to-Source Voltage		80	V
V _{GS}	Gate-to-Source Voltage		±20	V
1-	Continuous Drain Current	$T_{\rm C} = 25^{\circ}{\rm C}$	137	٨
۱ _D	Continuous Drain Current	T _C = 100°C	97	A
I _{DM}	Pulsed Drain Current ⁽¹⁾		Refer to Fig.4	А
E _{AS}	Single Pulsed Avalanche Energ	gy ⁽²⁾	662	mJ
PD	Rower Dissinction	$T_{c} = 25^{\circ}C$ 124	W	
۱D	Power Dissipation	T _C = 100°C	49	VV
T _J , T _{STG}	Junction & Storage Temperature	Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Мах	Unit	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient ⁽³⁾	40	°C/W	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.0	C/VV	

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					<u></u>
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	80	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64V, V_{GS} = 0V$	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics				ł	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	1.6	2.1	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_{D} = 20A$	-	2.4	3.4	mΩ
Dynami	ic Characteristics			•		
R_g	Gate Resistance	f = 1MHz	-	1.1	-	Ω
C _{iss}	Input Capacitance		-	4871	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 40V,$ f = 1MHz	-	1318	-	pF
C _{rss}	Reverse Transfer Capacitance		-	25	-	pF
Qg	Total Gate Charge		-	76	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 40V, I_D = 20A$	-	15	-	nC
Q_{gd}	Gate Drain("Miller") Charge	VDS = 400, 10 = 207	-	13	-	nC
Switchi	ing Characteristics					
t _{d(on)}	Turn-On DelayTime		-	17	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 39V	-	28	-	ns
t _{d(off)}	Turn-Off DelayTime	$I_{\rm D}$ = 20A, R _{GEN} = 6.2 Ω	-	80	-	ns
t _f	Turn-Off Fall Time	-	-	64	-	ns
Body D	iode Characteristics					
I _S	Maximum Continuous Body Diode Forward Current		-	-	137	А
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	-	550	А
$V_{\rm SD}$	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time		-	73	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 20A, di/dt = 100A/us		127	-	nC

Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise specified)

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

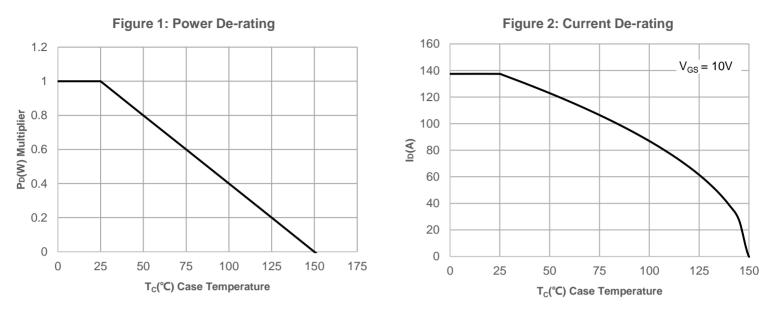
2. E_{AS} condition: Starting T_J =25C, V_{DD} =40V, V_G =10V, R_G =250hm, L=3mH, I_{AS} =21A, V_{DD} =0V during time in avalanche.

3. $R_{\theta JA}$ is measured with the device mounted on a 1inch 2 pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.

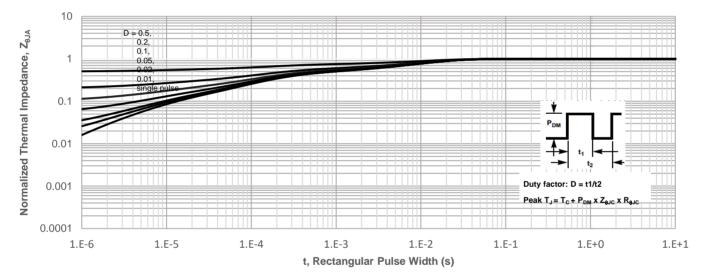




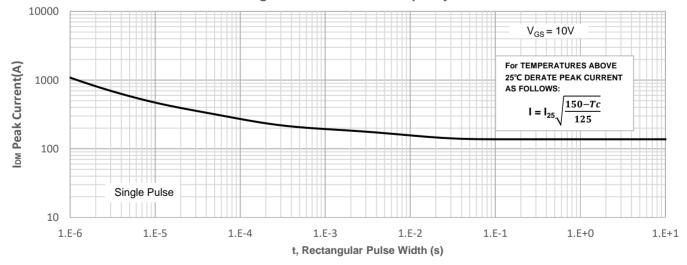


Typical Performance Characteristics

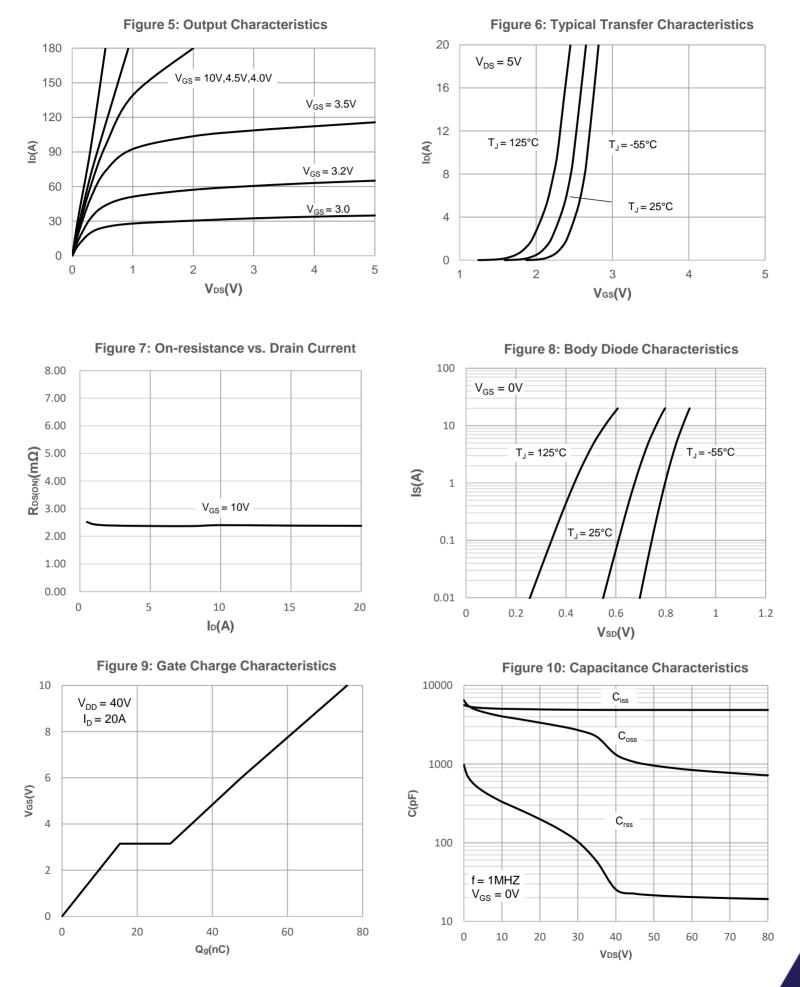












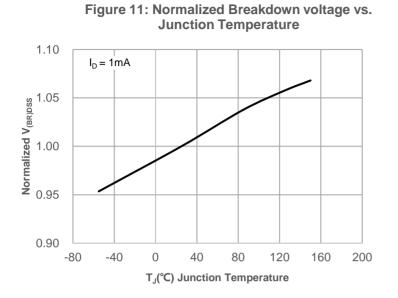
Typical Performance Characteristics

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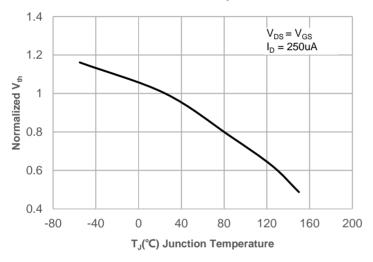
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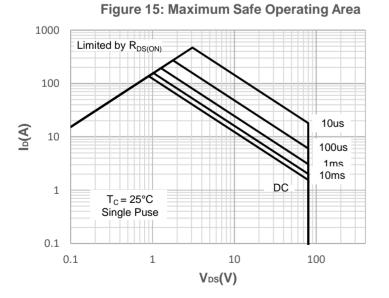


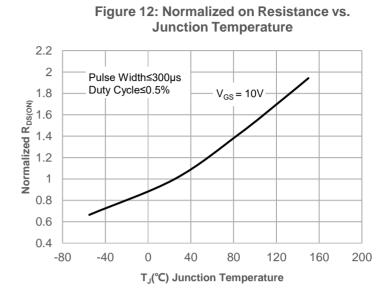
Typical Performance Characteristics



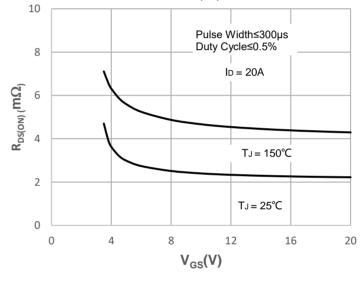














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Test Circuit

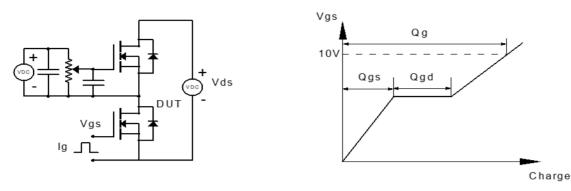


Figure 1: Gate Charge Test Circuit & Waveform

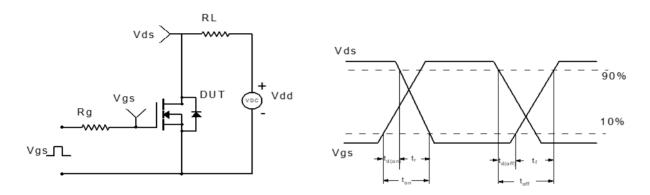


Figure 2: Resistive Switching Test Circuit & Waveform

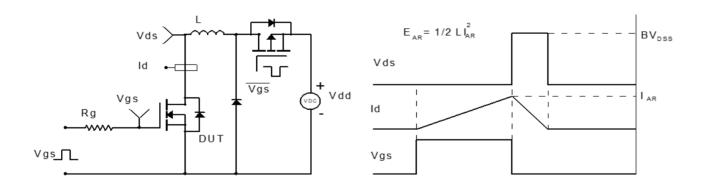


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

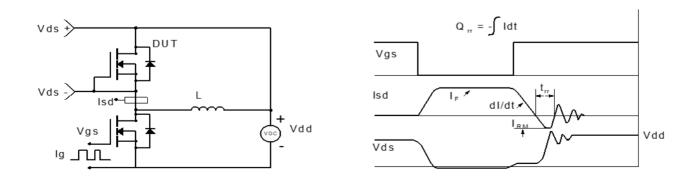
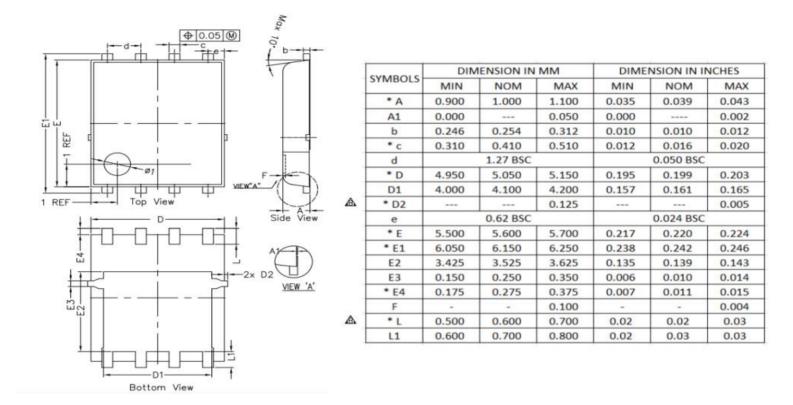


Figure 4: Diode Recovery Test Circuit & Waveform





Package Mechanical Data(PDFN5x6-8L)

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